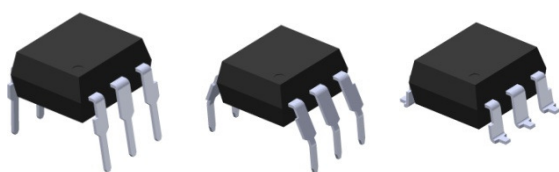


6 PIN DIP PHOTODARLINGTON PHOTOCOUPLER TIL113, 4NXX, H11BX Series



Features:

- 4NXX series: 4N29, 4N30, 4N31, 4N32, 4N33
- H11BX series: H11B1, H11B2, H11B3, H11B255
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +110 °C
- Compact small outline package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved

Description

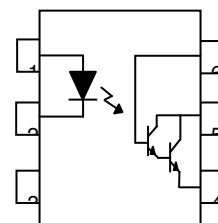
The TIL113, 4NXX and H11BX series of devices each consist of an infrared emitting diode optically coupled to a photo darlington detector.

They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Low power logic circuits
- Telecommunications equipment
- Portable electronics
- Interfacing coupling systems of different potentials and impedances

Schematic



Pin Configuration

1. Anode
2. Cathode
3. No Connection
4. Emitter
5. Collector
6. Base

Absolute Maximum Ratings (Ta=25°C)

| | Parameter | Symbol | Rating | Unit |
|--------|--|-----------|----------|-------|
| Input | Forward current | I_F | 60 | mA |
| | Peak forward current (1us, pulse) | I_{FP} | 1 | A |
| | Reverse voltage | V_R | 6 | V |
| | Power dissipation No derating required up to Ta = 100°C | P_D | 120 | mW |
| | | | 3.8 | mW/°C |
| Output | Power dissipation Derating factor (above Ta = 80°C) | P_C | 150 | mW |
| | | | 6.5 | mW/°C |
| | Collector-Emitter voltage | V_{CEO} | 55 | V |
| | Collector-Base voltage | V_{CBO} | 55 | V |
| | Emitter-Collector voltage | V_{ECO} | 7 | V |
| | Emitter-Base voltage | V_{EBO} | 7 | V |
| | Total power dissipation | P_{TOT} | 200 | mW |
| | Isolation voltage | V_{ISO} | 5000 | Vrms |
| | Operating temperature | T_{OPR} | -55~+100 | °C |
| | Storage temperature | T_{STG} | -55~+125 | °C |
| | Soldering temperature ^{*2} | T_{SOL} | 260 | °C |

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

| Parameter | Symbol | Min. | Typ.* | Max. | Unit | Condition |
|-------------------|----------|------|-------|------|---------------|--|
| Forward Voltage | V_F | - | 1.2 | 1.5 | V | $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ for H11B3 |
| Reverse Current | I_R | - | - | 10 | μA | $V_R = 6\text{V}$ |
| Input capacitance | C_{in} | - | 50 | - | pF | $V = 0, f = 1\text{MHz}$ |

Output

| Parameter | Symbol | Min. | Typ.* | Max. | Unit | Condition |
|-------------------------------------|------------|------|-------|------|------|-----------------------|
| Collector-Emitter dark current | I_{CEO} | - | - | 100 | nA | $V_{CE} = 10\text{V}$ |
| Collector-Emitter breakdown voltage | BV_{CEO} | 55 | - | - | V | $I_C = 1\text{mA}$ |
| Emitter-Collector breakdown voltage | BV_{CBO} | 55 | - | - | V | $I_C = 0.1\text{mA}$ |
| Emitter-Collector breakdown voltage | BV_{ECO} | 7 | - | - | V | $I_E = 0.1\text{mA}$ |

Transfer Characteristics (Ta=25°C unless specified otherwise)

| Parameter | Symbol | Min | Typ. | Max. | Unit | Condition |
|------------------------|--------------|-----|------|------|------|--|
| Current transfer ratio | 4N32 4N33 | 500 | - | - | | $I_F = 10\text{mA}, V_{CE} = 10\text{V}$ |
| | 4N29 4N30 | 100 | - | - | | |
| | 4N31 | 50 | - | - | | |
| | H11B1 | 500 | - | - | % | $I_F = 1\text{mA}, V_{CE} = 5\text{V}$ |
| | H11B2 | 200 | - | - | | |
| | H11B3 | 100 | - | - | | |
| | H11B255 | 100 | - | - | | $I_F = 10\text{mA}, V_{CE} = 5\text{V}$ |
| | TIL113 | 300 | - | - | | $I_F = 10\text{mA}, V_{CE} = 1\text{V}$ |

Transfer Characteristics ($T_a=25^{\circ}\text{C}$ unless specified otherwise)

| Parameter | Symbol | Min | Typ. | Max. | Unit | Condition |
|--------------------------------------|--|-----------|------|------|---------------|--|
| Collector-emitter saturation voltage | 4N29 4N30 4N32 4N33 | - | - | 1.0 | | $I_F = 8\text{mA}, I_C = 2\text{mA}$ |
| | 4N31 TIL113 | - | - | 1.2 | V | $I_F = 8\text{mA}, I_C = 2\text{mA}$ |
| | H11B1 H11B2 H11B3 | - | - | 1.0 | | $I_F = 1\text{mA}, I_C = 1\text{mA}$ |
| | H11B255 | - | - | 1.0 | | $I_F = 50\text{mA}, I_C = 50\text{mA}$ |
| Isolation resistance | R_{IO} | 10^{11} | - | - | Ω | $V_{IO} = 500\text{Vdc}$ |
| Input-output Capacitance | C_{IO} | - | 0.8 | - | pF | $V_{IO} = 0, f = 1\text{MHz}$ |
| Turn-on time | H11B1 H11B2 H11B3 H11B255 | - | 25 | - | | $V_{CC} = 10\text{V}, I_F = 10\text{mA}, R_L = 100\Omega$ |
| | 4N29 4N30 4N31 4N32 4N33 TIL113 | - | - | 5 | μs | $V_{CC} = 10\text{V}, I_C = 50\text{mA}, I_F = 200\text{mA}$ |
| | H11B1 H11B2 H11B3 H11B255 | - | 18 | - | | $V_{CC} = 10\text{V}, I_F = 10\text{mA}, R_L = 100\Omega$ |
| | 4N32 4N33 TIL113 | - | - | 100 | μs | $V_{CC} = 10\text{V}, I_C = 50\text{mA}, I_F = 200\text{mA}$ |
| Turn-off time | 4N29 4N30 4N31 | - | - | 40 | | |

* Typical values at $T_a = 25^{\circ}\text{C}$

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

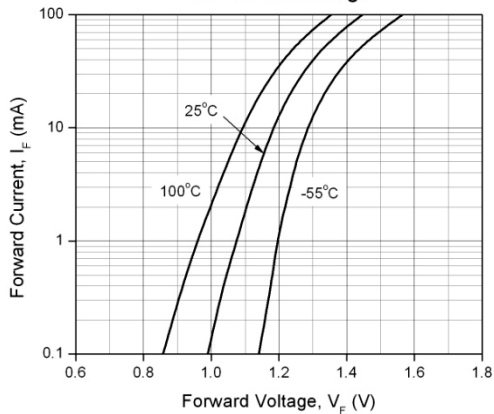


Figure 2. Current Transfer Ratio vs. Ambient Temperature

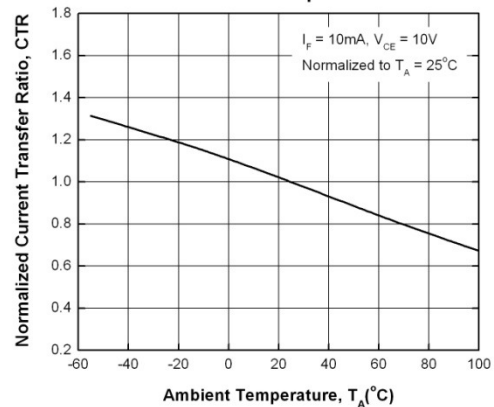


Figure 3. Normalized Current Transfer Ratio vs Forward Current

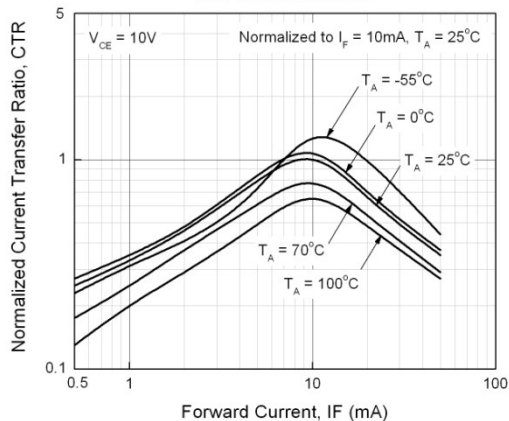


Figure 4. Collector Dark Current vs Ambient Temperature

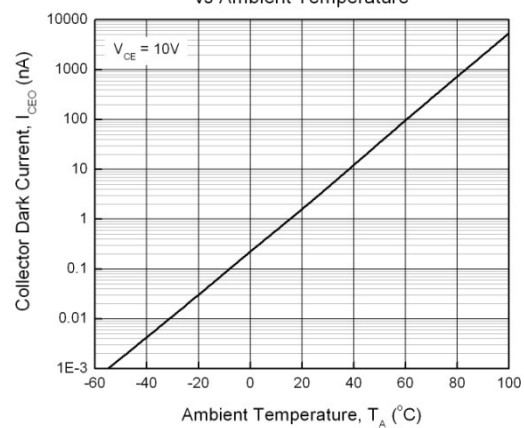


Figure 5. Turn-on Time vs Forward Current

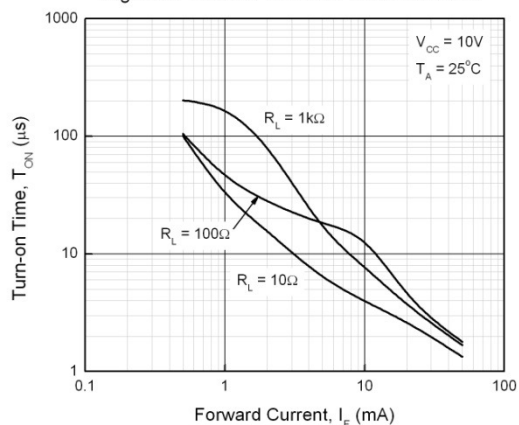
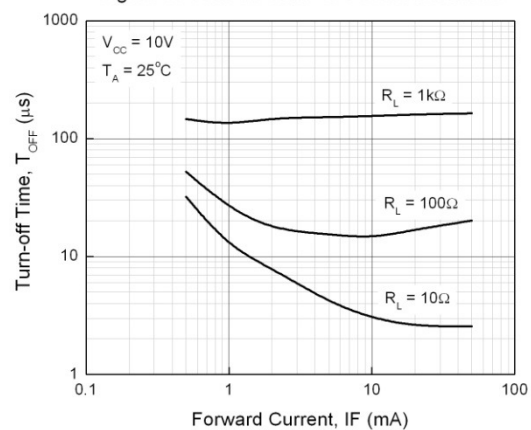


Figure 6. Turn-off Time vs Forward Current



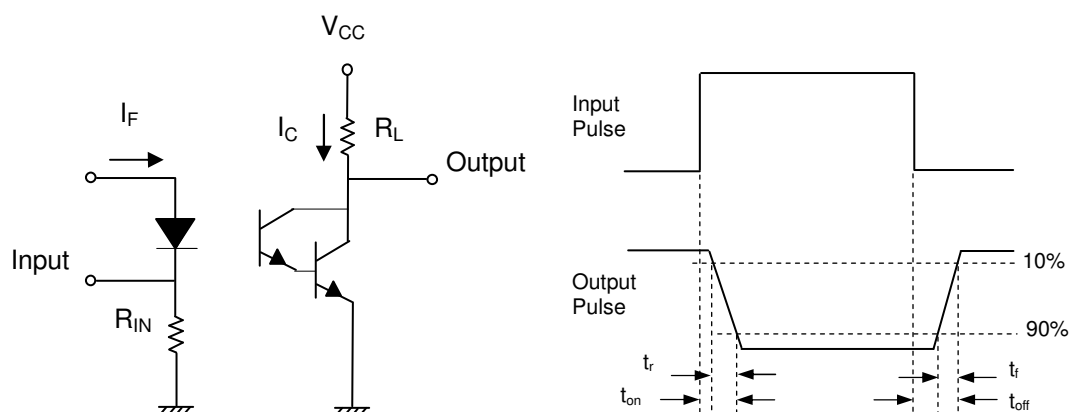


Figure 7. Switching Time Test Circuit & Waveforms

Order Information

Part Number

4NXXY(Z)-V
or **H11BXY(Z)-V**
or **TIL113Y(Z)-V**

Note

XX = Part No. for 4NX series (29, 30, 31, 32 or 33)

X = Part No. for H11BX series (1, 2, 3 or 255)

Y = Lead form option (S, S1, M or none)

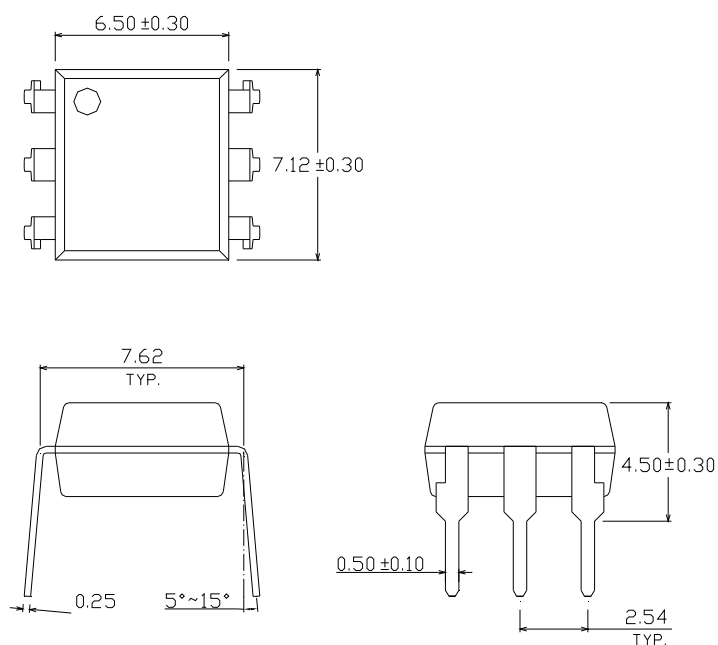
Z = Tape and reel option (TA, TB or none).

V = VDE safety (optional)

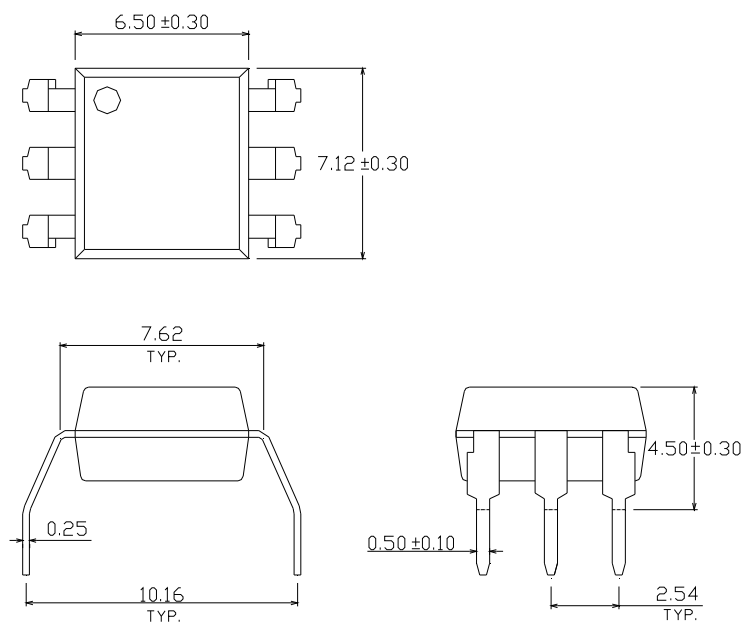
| Option | Description | Packing quantity |
|---------|---|---------------------|
| None | Standard DIP-6 | 65 units per tube |
| M | Wide lead bend (0.4 inch spacing) | 65 units per tube |
| S (TA) | Surface mount lead form + TA tape & reel option | 1000 units per reel |
| S (TB) | Surface mount lead form + TB tape & reel option | 1000 units per reel |
| S1 (TA) | Surface mount lead form (low profile) + TA tape & reel option | 1000 units per reel |
| S1 (TB) | Surface mount lead form (low profile) + TB tape & reel option | 1000 units per reel |

Package Dimension (Dimensions in mm)

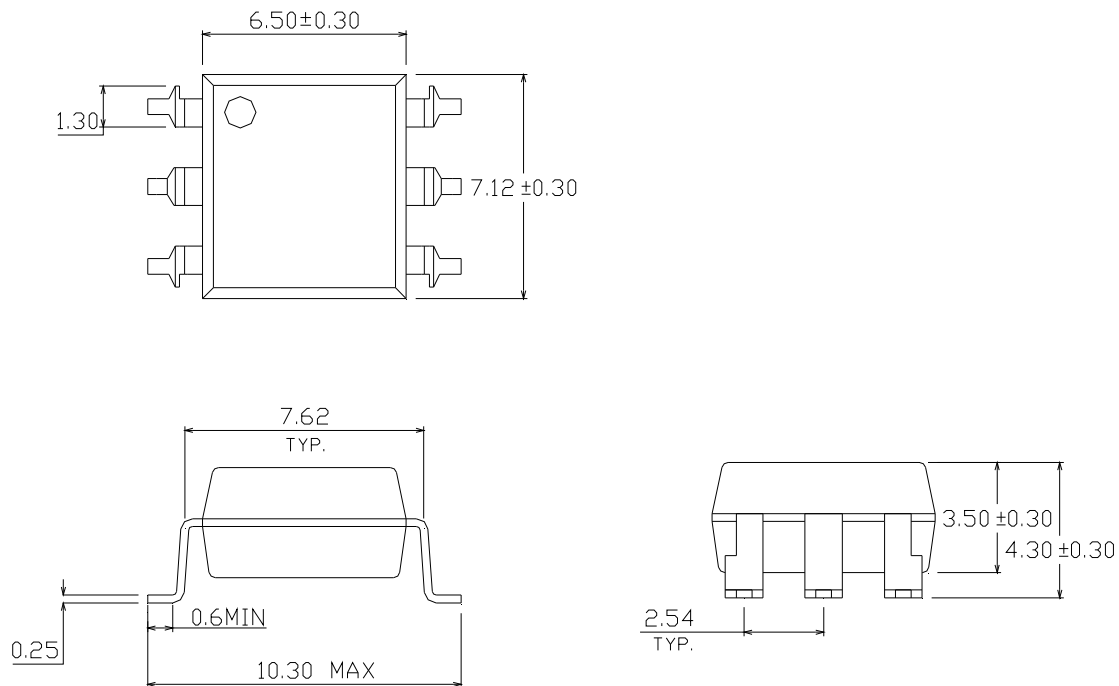
Standard DIP Type



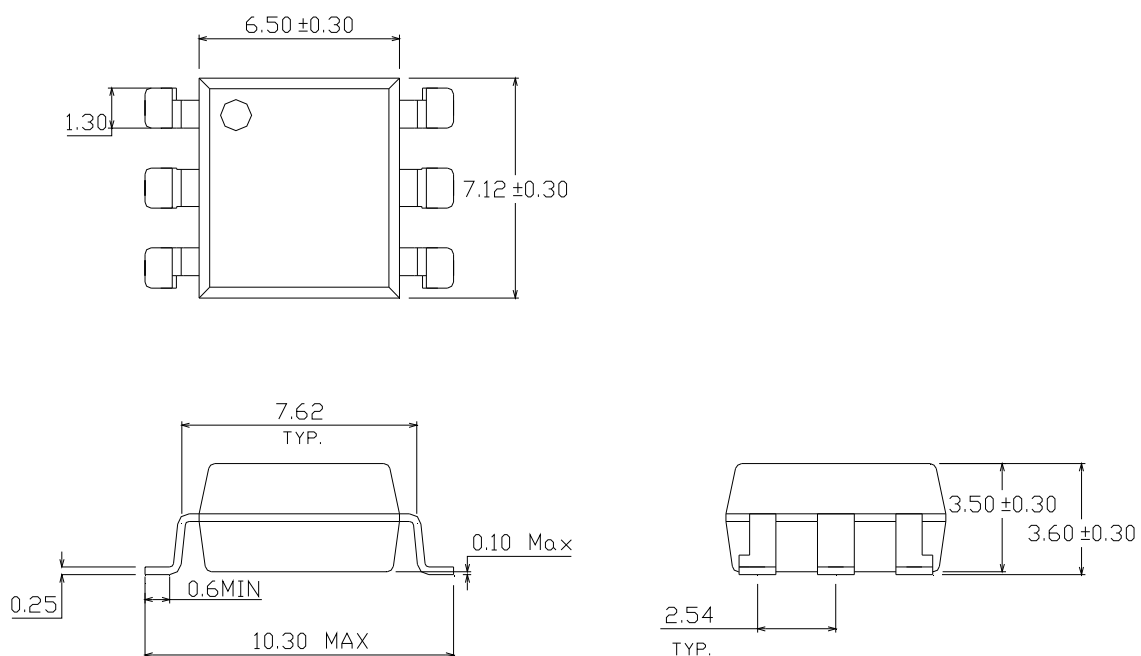
Option M Type



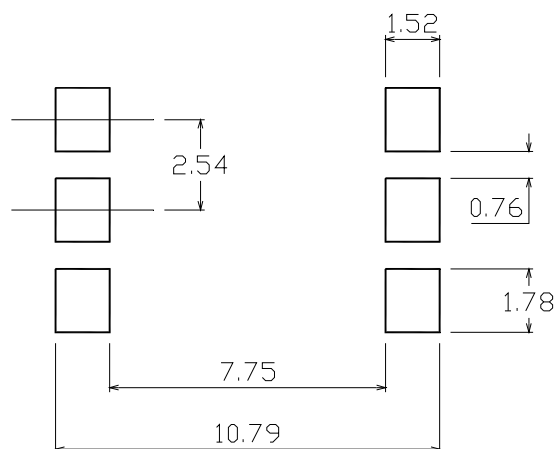
Option S Type



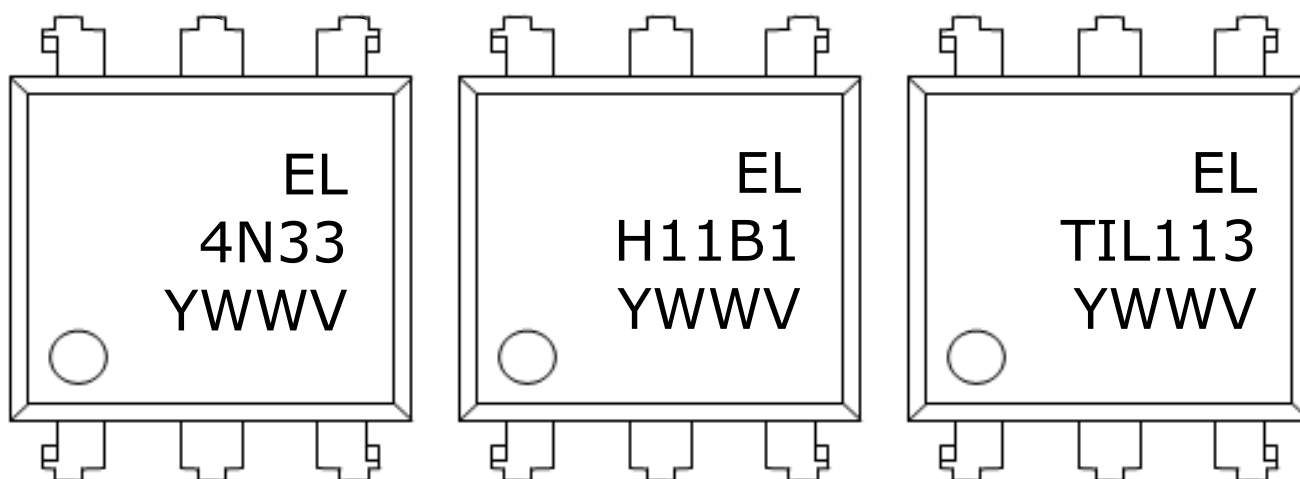
Option S1 Type



Recommended pad layout for surface mount leadform



Device Marking

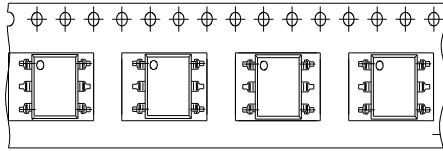


Notes

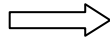
| | |
|--------|-------------------------------|
| EL | denotes Everlight |
| 4N33 | |
| TIL113 | |
| H11B1 | denotes Part Number |
| Y | denotes 1 digit Year code |
| WW | denotes 2 digit Week code |
| V | denotes VDE safety (optional) |

Tape & Reel Packing Specifications

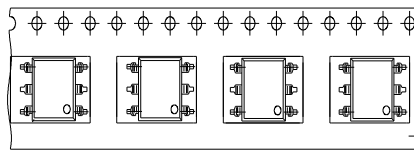
Option TA



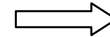
Direction of feed from reel



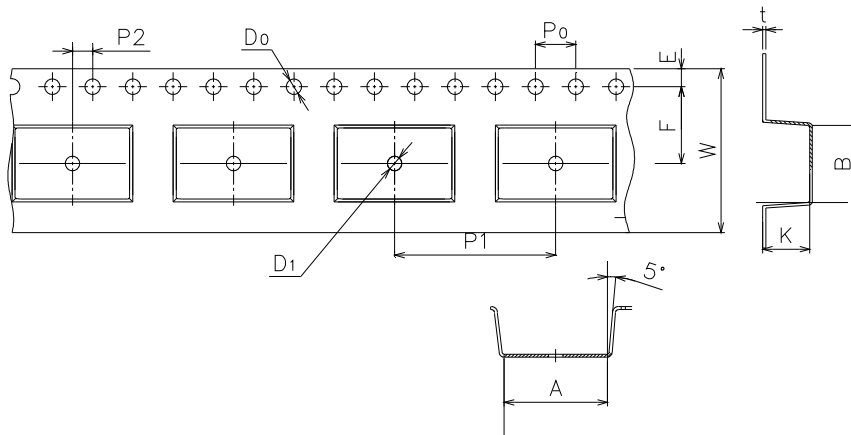
Option TB



Direction of feed from reel



Tape dimensions

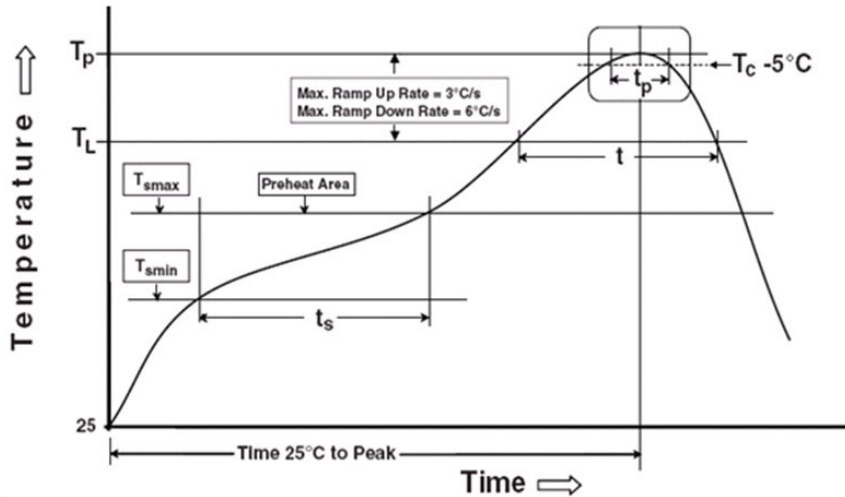


| Dimension No. | A | B | D0 | D1 | E | F |
|---------------|----------|---------|---------|------------|----------|---------|
| Dimension(mm) | 10.4±0.1 | 7.5±0.1 | 1.5±0.1 | 1.5+0.1/-0 | 1.75±0.1 | 7.5±0.1 |
| Dimension No. | P0 | P1 | P2 | t | W | K |
| Dimension(mm) | 4.0±0.15 | 12±0.1 | 2.0±0.1 | 0.35±0.03 | 16.0±0.2 | 4.5±0.1 |

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

| | |
|--|-----------------|
| Temperature min (T_{smin}) | 150 °C |
| Temperature max (T_{smax}) | 200 °C |
| Time (T_{smin} to T_{smax}) (t_s) | 60-120 seconds |
| Average ramp-up rate (T_{smax} to T_P) | 3 °C/second max |

Other

| | |
|--|-------------------|
| Liquidus Temperature (T_L) | 217 °C |
| Time above Liquidus Temperature (t_L) | 60-100 sec |
| Peak Temperature (T_P) | 260 °C |
| Time within 5 °C of Actual Peak Temperature: $T_P - 5^\circ\text{C}$ | 30 s |
| Ramp- Down Rate from Peak Temperature | 6 °C /second max. |
| Time 25 °C to peak temperature | 8 minutes max. |
| Reflow times | 3 times |

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